

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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High Current, Low-Profile Power Inductors

FLAT-PAC™ FP0705 Series



Description

- 125°C maximum total temperature operation
- 7.0 x 7.0 x 4.95mm surface mount package
- Ferrite core material, High current carrying capacity
- · Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 72nH to 220nH
- Current range from 20 to 65 Amps, frequency range up to 2MHz
- RoHS compliant

Applications

- Portable electronics
- Servers and workstations
- · Data networking and storage systems
- Notebook and desktop computers
- · Graphics cards and battery power systems
- Multi-phase regulators
- Voltage Regulator Module (VRM)
- DCR sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (Range is application specific)
- Solder reflow temperature: J-STD-020D compliant

Packaging

 Supplied in tape-and-reel packaging, 950 parts per reel, 13" dia. reel

RoHS 2002/95/EC

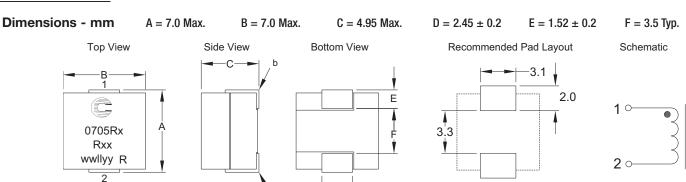
			Product	Specifications			
Part Number	OCL1 ± 10% (nH)	FLL ² Min. (nH)	1		I _{sat} 2 ⁵ @ 125°C (Amps)	DCR (m0hm)@20°C	K-factor ⁶
R1 Version							
FP0705R1-R07-R	72	51		65	50		826
FP0705R1-R10-R	105	75		44	36		826
FP0705R1-R12-R	120	86	43	37	30	0.05 . 100/	826
FP0705R1-R15-R	150	108	43	30	24	0.25 ± 10%	826
FP0705R1-R18-R	180	130		25	20		826
FP0705R1-R22-R	220	158		20	16		826
R2 Version							
FP0705R2-R07-R	72	51		65	50		826
FP0705R2-R10-R	105	75		44	36		826
FP0705R2-R12-R	120	86	200	37	30	0.00 . 0.40/	826
FP0705R2-R15-R	150	108	38	30	24	$0.32 \pm 9.4\%$	826
FP0705R2-R18-R	180	130		25	20		826
FP0705R2-R22-R	220	158		20	16		826
R3 Version							
FP0705R3-R07-R	72	51		65	50		826
FP0705R3-R10-R	105	75		44	36		826
FP0705R3-R12-R	120	86	20	37	30	0.40 . 0.50/	826
FP0705R3-R15-R	150	108	32	30	24	$0.46 \pm 6.5\%$	826
FP0705R3-R18-R	180	130		25	20		826
FP0705R3-R22-R	220	158		20	16		826

- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V $_{\rm rms}$, 0.0Adc
- 2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1 V_{rms} , I_{sat} 1
- 3 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.
- 4 I_{sat}1: Peak current for approximately 20% rolloff at +25°C.
- 5 I_{sat}2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I * 10^{-3}$, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP0705Rx-Rxx-R
 - FP0705 = Product code and size
- Rx is the DCR indicator
- Rxx= Inductance value in μ H, R = decimal point
- "-R" suffix = RoHS compliant



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Part Marking: Coiltronics Logo

0705Rx (Rx = DCR indicator)

Nominal DCR is measured from point "a" to point "b.

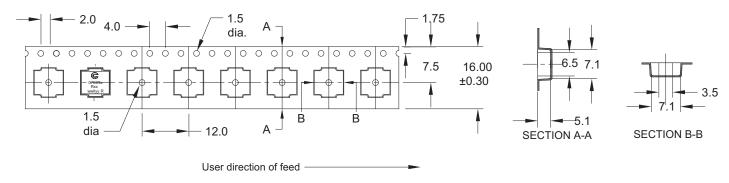
 $\mbox{Rxx} = \mbox{inductance value in } \mu \mbox{H (R} = \mbox{decimal point)}$

-D--

wwllyy = date code

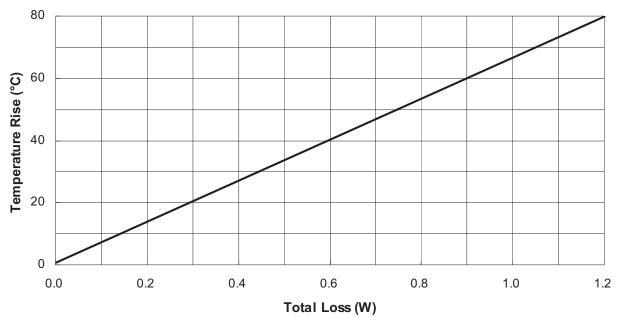
date code R = revision level

Packaging Information - mm



Supplied in tape-and-reel packaging, 950 parts per reel, 13" diameter reel.

Temperature Rise vs. Total Loss

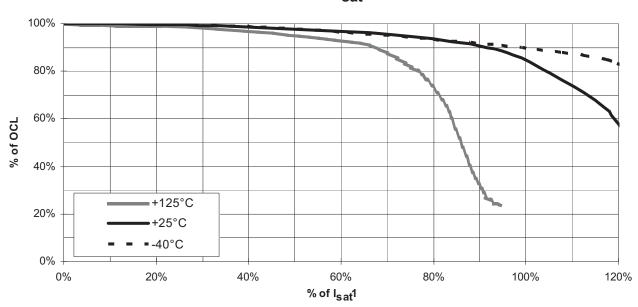


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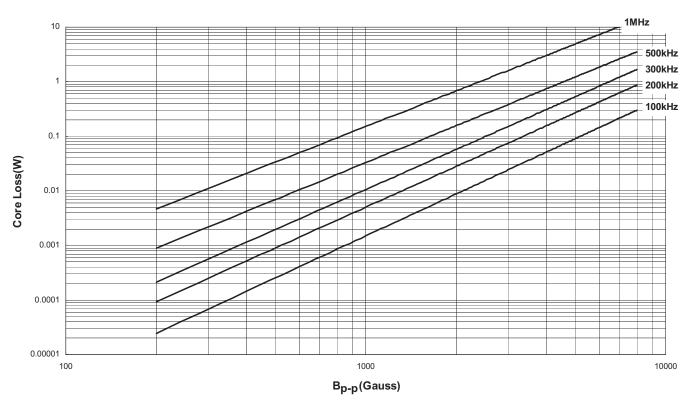
Inductance Characteristics





Core Loss

Core Loss vs. B_{p-p}



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Solder Reflow Profile

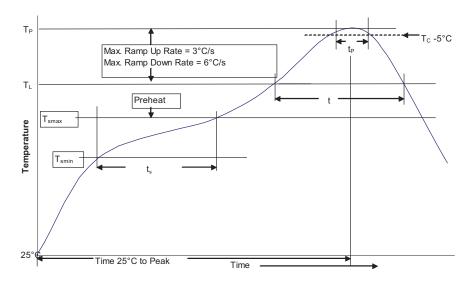


Table 1 - Standard SnPb Solder (T_C)

	Volume	Volume
Package	mm ³	mm ³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm ³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	 Temperature min. (T_{smin}) 	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rat	te T _{smax} to T _p	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down	rate (T _p to T _{smax})	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (T_{p}) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.